

ON Semiconductor®

FDBL9406-F085

N-Channel PowerTrench[®] MOSFET 40 V, 240 A, 1.2 m Ω

Features

- Typical $R_{DS(on)}$ = 0.9 m Ω at V_{GS} = 10V, I_D = 80 A
- Typical $Q_{g(tot)}$ = 90 nC at V_{GS} = 10V, I_D = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems



MOSFET Maximum Rating 25 unless unerwise noted

| Symbol | rameter | Ratings | Units |
|-------------------------|---|--------------|-------|
| V_{DSS} | Drain-to-Sr , ce Voltage | 40 | V |
| V_{GS} | Gate-to-Scrice Volta : | ±20 | V |
| 1_ | r ain currei Cont Jous (V _{GS} −10) (Note 1) T _C = 25°C | 240 | Α |
| ID | n Current $T_C = 25^{\circ}C$ | See Figure 4 | ^ |
| FAS | Single Pi [*] Avalanch & Energy (Note 2) | 316 | mJ |
| 1 _D | 'owe, ussipation | 300 | W |
| P_{D} | L _rate Abo re 2 ^{r,o} C | 2.0 | W/°C |
| T_{J}, T_{G} | Operating and Storage Temperature | -55 to + 175 | οС |
| , JC | Thermal Resistance, Junction to Case | 0.5 | °C/W |
| $R_{\theta J' \lambda}$ | Maximum 1 hermal Resistance, Junction to Ambient (Note 3) | 43 | °C/W |

Notes:

- 1: Current is limited by 50 to vire configuration.
- 2: Starting $T_J = 25^{\circ}C$, L = 0.1mH, $I_{AS} = 79.5$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3: R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,JC} is guaranteed by design, while R_{0,JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

| Device Marking | Device | Package | | | |
|----------------|---------------|---------|---|---|---|
| FDBL9406 | FDBL9406-F085 | MO-299A | - | - | - |

Units

Max.

Electrical Characteristics $T_J = 25$ °C unless otherwise noted.

Parameter

| Off Characteristics | | | | | | | | |
|---------------------|-----------------------------------|-----------------------|---------------------------------------|----|---|------|----|--|
| B _{VDSS} | Drain-to-Source Breakdown Voltage | $I_D = 250 \mu A$, | V _{GS} = 0V | 40 | - | - | V | |
| I _{DSS} | Drain-to-Source Leakage Current | V _{DS} =40V, | $T_J = 25^{\circ}C$ | - | - | 1 | μА | |
| | | $V_{GS} = 0V$ | $T_J = 175^{\circ}C \text{ (Note 4)}$ | - | - | 1 | mA | |
| IGSS | Gate-to-Source Leakage Current | $V_{GS} = \pm 20V$ | 1 | - | - | ±100 | nA | |

Test Conditions

Min.

Тур.

On Characteristics

Symbol

| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}$, I | _D = 250μA | 2.0 | 3 2 | | V |
|---------------------|-----------------------------------|-----------------------|---------------------------------------|-----|------|-----|----|
| R _{DS(on)} | Il Irain to Source (In Registance | I _D = 80A, | $T_{J} = 25^{\circ}C$ | - | 0. | 1.2 | mΩ |
| | | V _{GS} = 10V | $T_J = 175^{\circ}C \text{ (Note 4)}$ | | 1.64 | 1.8 | mΩ |

Dynamic Characteristics

| | | | | 1 |
|--------------------|-------------------------------|--|---------|-----|
| C _{iss} | Input Capacitance | V - 25V V - 0V | . 735 - | pF |
| C _{oss} | Output Capacitance | V _{DS} = 25V, V _{GS} = 0V, | 216 - | pF |
| C _{rss} | Reverse Transfer Capacitance | - 1101112 | 29 - | pF |
| R_g | Gate Resistance | f = 1MH- | 2.5 - | Ω |
| $Q_{g(ToT)}$ | Total Gate Charge at 10V | V _C to 10 = 32V - | 90 107 | 110 |
| Q _{g(th)} | Threshold Gate Charge | $V_{GS} = 2V$ $I_D = 85A$ - | 135 135 | nC |
| Q_{gs} | Gate-to-Source Gate Charge | 106.0 | 43 | nC |
| Q_{gd} | Gate-to-Drain "Miller" Charge | NV D | 10 - | nC |

Switching Characteristic

| t _{on} | Turn-On Tir | - | - | 102 | ns |
|-----------------|---|---|----|-----|----|
| $t_{d(on)}$ | Turn-On [lay | - | 33 | 1 | ns |
| t _r | $V_{DD} = 20 \text{ V, } I_D = 80 \text{A,}$ | - | 40 | 1 | ns |
| $t_{d(off)}$ | urn-O" Deic $V_{33} = 10V, R_{GEN} = 6\Omega$ | - | 47 | 1 | ns |
| t _f | I TIME | - | 23 | - | ns |
| | Tu of .ime | - | - | 91 | ns |

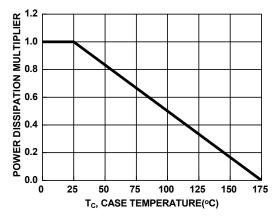
Drain Source Didge Characteristics

| Source-to-Prain Didue Voltage | I_{SD} =80A, V_{GS} = 0V | - | - | 1.25 | V |
|---|---|---|-----|------|----|
| Scurse-to-1.4.1 Diode Vollage | I_{SD} = 40A, V_{GS} = 0V | - | - | 1.2 | V |
| t _r Reverse-Recovery (in te | $I_F = 80A$, $dI_{SD}/dt = 100A/\mu s$, | 1 | 91 | 107 | ns |
| O _{rr} Reverse-Recovery Charge | V _{DD} =32V | - | 128 | 167 | nC |

Note:

4: The maximum value 13 specified by design at T_J = 175°C. Product is not tested to this condition in production.

Typical Characteristics



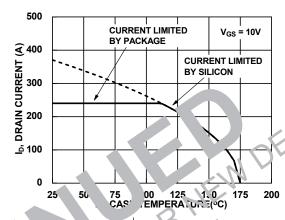
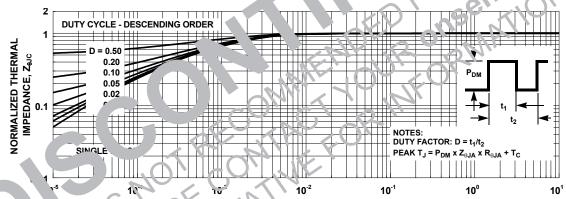


Figure 1. Normalized Power Dissipation vs. Case Temperature

່ງພ. ເ. num Cor ແນນວພຣ Drain Current vs. Case ໂອພາກຸອerature



t, RICIANGULAR PULSE DURATION(s)
Figure 3. Normalized Maximum Transient Thermal Impedance

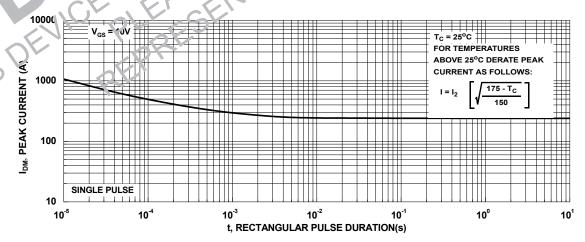


Figure 4. Peak Current Capability

Typical Characteristics

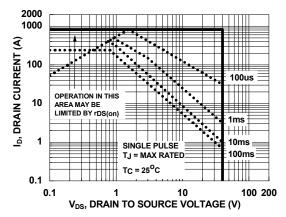


Figure 5. Forward Bias Safe Operating Area

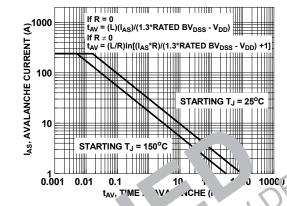
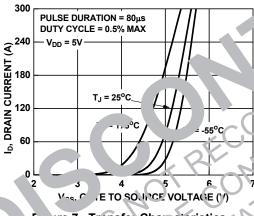


Figure 6. Ut lan ad Inc active Switching Capability



F. re 7. Transfer Characteristics

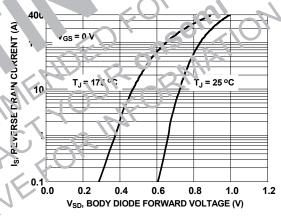


Figure 8. Forward Diode Characteristics

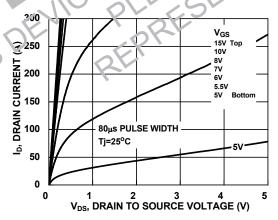


Figure 9. Saturation Characteristics

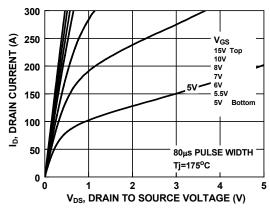


Figure 10. Saturation Characteristics

Typical Characteristics

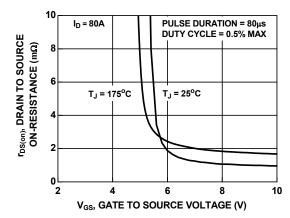


Figure 11. R_{DSON} vs. Gate Voltage

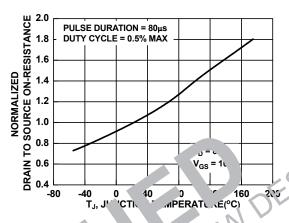
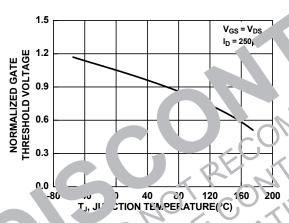


Figure 12 Norma rea SON vs. Junction Ten grature



Figu 15 lormalized Gate Threshold Voltage vs.

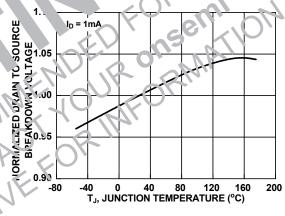


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

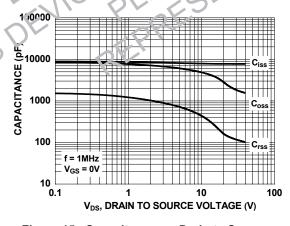


Figure 15. Capacitance vs. Drain to Source Voltage

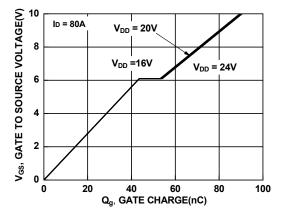


Figure 16. Gate Charge vs. Gate to Source Voltage



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